

CMOS 4-Bit Microcontroller

**TMP47P403VN**  
**TMP47P403VM**

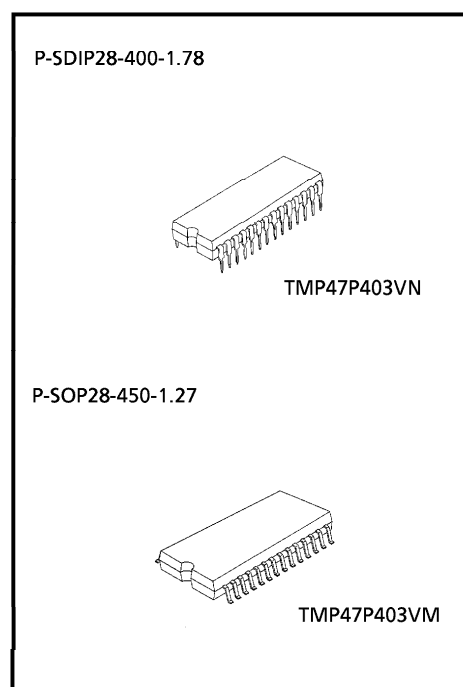
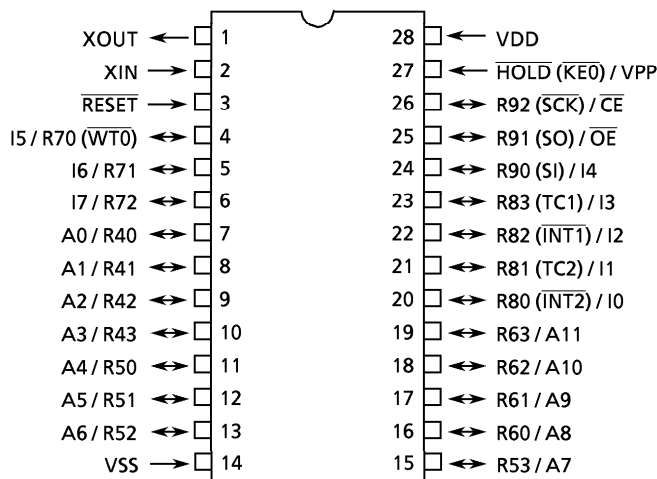
The TMP47P403V is the system evaluation LSI of TMP47C103/203 with a 32-Kbit one-time PROM. The TMP47P403V programs / verifies using an adaptor socket to connect with PROM programmer, as it is in TMM27256AD.

In addition, the TMP47P403V and the TMP47C103/203 are pin compatible. The TMP47P403V operates as the same as the TMP47C103/203 by programming to the internal PROM.

| Part No.    | ROM          | RAM         | Package           | Adaptor Socket |
|-------------|--------------|-------------|-------------------|----------------|
| TMP47P403VN | OTP          | 128 × 4-bit | P-SDIP28-400-1.78 | BM1140         |
| TMP47P403VM | 4096 × 8-bit |             | P-SOP28-450-1.27  | BM1141         |

**Pin Assignment (Top View)**

P-SDIP28-400-1.78 / P-SOP28-450-1.27



000707EBA1

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**Pin Function**

The TMP47P403V has MCU mode and PROM mode.

## (1) MCU mode

The TMP47C103/203 and the TMP47P403V are pin compatible.

## (2) PROM mode

| Pin Name           | Input / Output | Functions                                      | Pin Name (MCU mode) |
|--------------------|----------------|--|---------------------|
| A11 to A8          | Input          | Address inputs                                 | R63 to R60          |
| A7 to A4           |                |  | R53 to R50          |
| A3 to A0           |                |  | R43 to R40          |
| I7 to I5           | I/O            | Data inputs / outputs                          | R72 to R70          |
| I4                 |                |  | R90                 |
| I3 to I0           |                |  | R83 to R80          |
| $\overline{CE}$    | Input          | Chip Enable input                              | R92                 |
| $\overline{OE}$    |                | Output Enable input                            | R91                 |
| VPP                | Power supply   | + 12.5 V / 5 V (Program supply voltage)        | $\overline{HOLD}$   |
| VCC                |                | + 5 V  | VDD                 |
| VSS                |                | 0 V  | VSS                 |
| $\overline{RESET}$ | Input          | PROM mode setting pin. Be fixed to low level.  |                     |
| XIN                | Input          | Input the clock from the external oscillator.  |                     |
| XOUT               | Input          | Be pulled up to VCC level. (750 $\Omega$ typ.) |                     |

## Operational Description

The following is an explanation of hardware configuration and operation in relation to the TMP47P403V. The TMP47P403V is the same as the TMP47C103/203 except that an OTP is used instead of a built-in mask ROM.

### 1. Operation mode

The TMP47P403V has an MCU mode and a PROM mode.

#### 1.1 MCU mode

The MCU mode is set by attaching a resonator between the XIN and Xout pins. Operation in the MCU mode is the same as for the TMP47C103/203. In the TMP47P403V, RC oscillation is impossible.

##### 1.1.1 Program Memory

The program storage area are as shown in Figure 1-1. Data conversion tables must be set in two locations when using the TMP47P403V to check TMP47C103/203 operation.

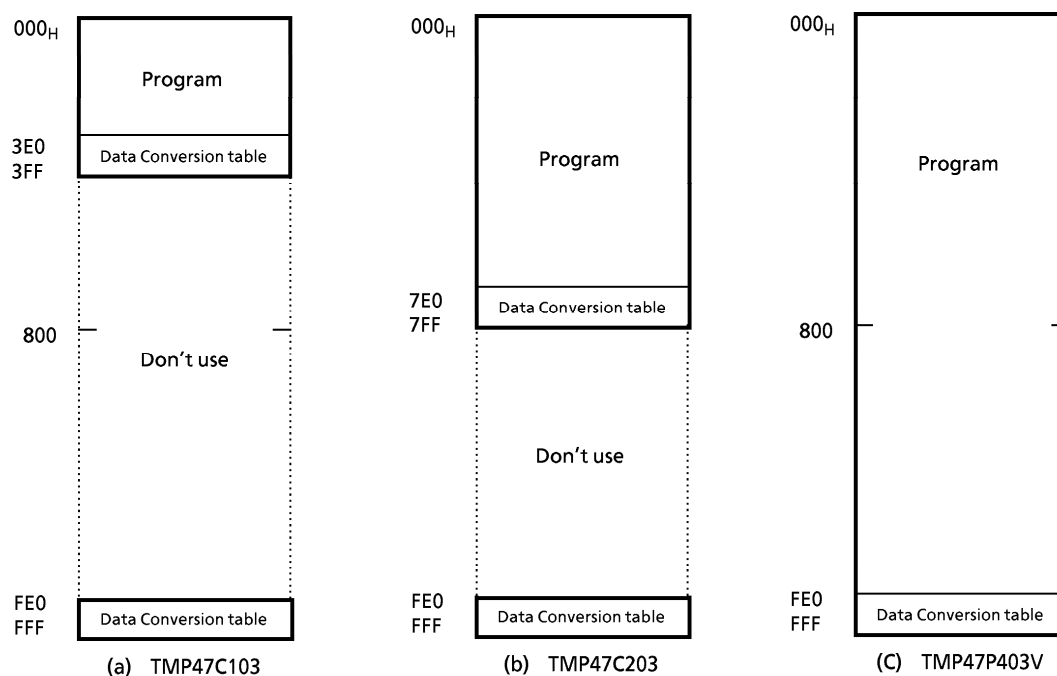


Figure 1-1. Program area

### 1.1.2 Data Memory

The TMP47P403V has  $128 \times 4$ -bit of data memory (RAM). When the TMP47P403V is used as the TMP47C103 evaluator, programming should be performed assuming that the RAM is assigned to addresses  $00_H$  to  $0F_H$  and  $50_H$  to  $7F_H$  as shown in Figure 1-2 (a).

At the Real time emulator (BM47C203), RAM is assigned to addresses  $00_H$  to  $FF_H$ . However, programming should be performed assuming that the RAM is assigned as shown in Figure 1-2 (a).

Further, zero-page (addresses  $00_H$  to  $0F_H$ ) and special function shared area (Stack location 0 to 3) are overlapped on the TMP47C103.

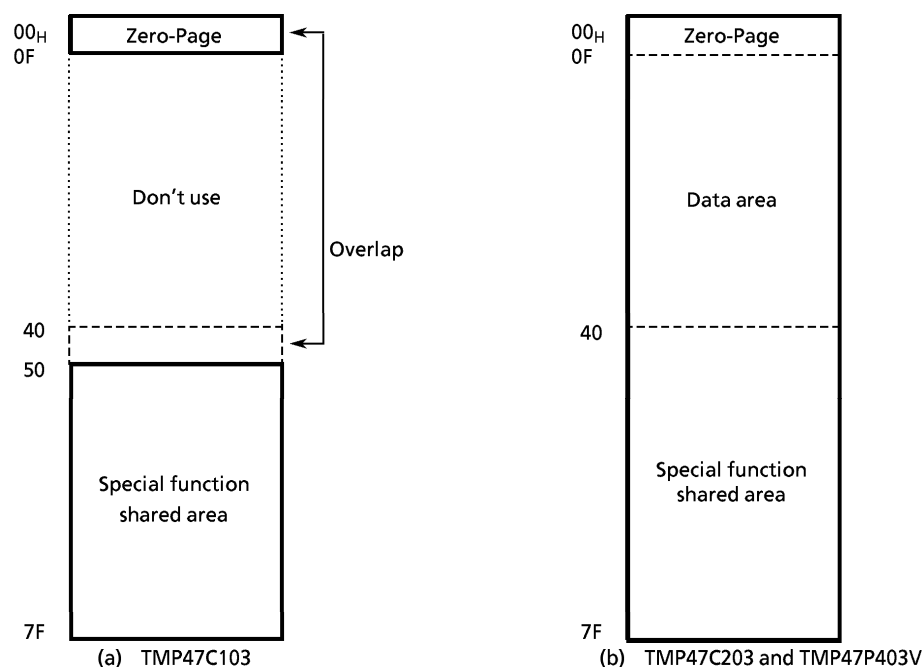


Figure 1-2.

### 1.1.3 Input / Output Circuitry

#### (1) Control pins

This is the same as for the TMP47C103/203. In the TMP47P403V, RC oscillation is impossible. Connecting the resonator or inputting the external clock to XIN pin are required when using as evaluator of I/O code FD, FE.

#### (2) I/O Ports

The input / output circuit of the TMP47P403V is the same as I/O code FA, FD of the TMP47C103/203. External resistance, for example, is required when using as evaluator of other I/O codes (FB, FE).

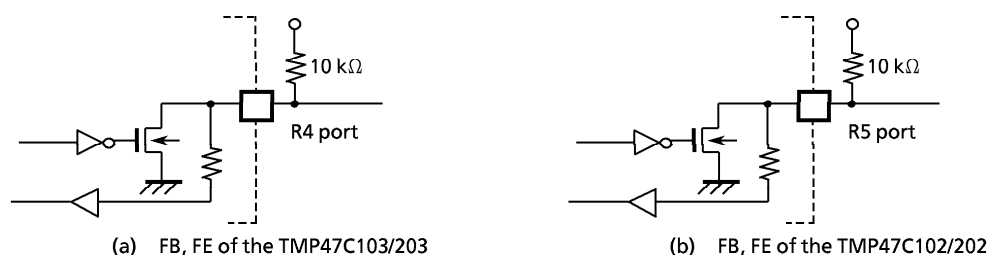


Figure 1-3. I/O code and external circuitry

## 1.2 PROM mode

The PROM mode is set by inputting the external clock to the XIN pin when XOUT pin is pulled up to the VCC level. In PROM mode, programs can be written or verified using a general-purpose PROM writer with an adapter socket being attached.

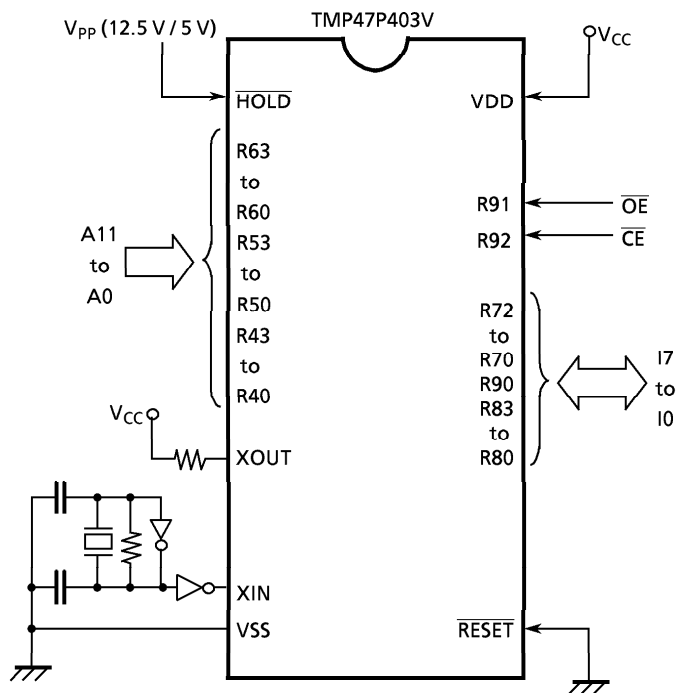


Figure 1-4. Setting for PROM mode

### 1.2.1 Program Writing

When writing a program, set a ROM type to "27256A" (programming voltage: 12.5 V) . Since the TMP47P403V has a 4096 × 8-bit internal PROM (000 to FFF<sub>H</sub>) , set a stop address of a PROM writer to "FFF<sub>H</sub>". For a general-purpose PROM writer, use the writer which does not have or can release an electric signature mode.

### 1.2.2 High Speed Programming Mode

The program time can be greatly decreased by using this high speed programming mode. The device is set up in the high speed programming mode when the programming voltage (+ 12.5 V) is applied to the  $V_{PP}$  terminal with  $V_{CC} = 6 V$  and  $\overline{CE} = V_{IH}$ .

The programming is achieved by applying a single low level 1ms pulse the  $\overline{CE}$  input after addresses and data are stable. Then the programmed data is verified by using Program Verify Mode.

If the programmed data is not correct, another program pulse of 1ms is applied and then programmed data is verified. This should be repeated until the program operates correctly (max. 25 times).

After correctly programming the selected address, one additional program pulse with pulse width 3 times that needed for programming is applied.

When programming has been completed, the data in all addresses should be verified with  $V_{CC} = V_{PP} = 5 V$ .

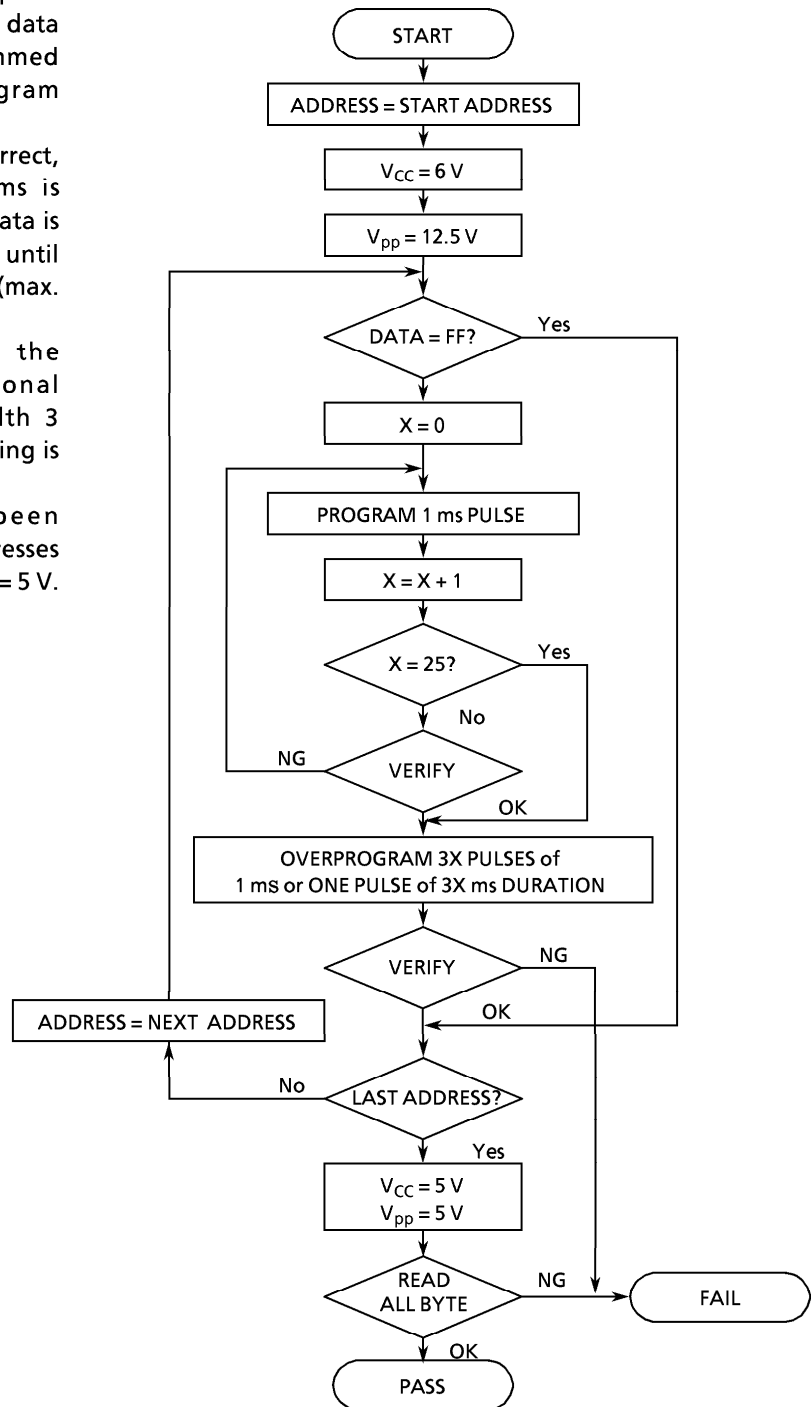


Figure 1-5. Flowchart

## Electrical Characteristics

Absolute Maximum Ratings (V<sub>SS</sub> = 0 V)

| Parameter                                   | Symbol             | Pins             | Ratings                        | Unit |    |
|---|--------------------|------------------|--------------------------------|------|----|
| Supply Voltage                              | V <sub>DD</sub>    |                  | - 0.3 to 6.5                   | V    |    |
| Program Voltage                             | V <sub>PP</sub>    | HOLD / VPP pin   | - 0.3 to 13.0                  | V    |    |
| Input Voltage                               | V <sub>IN</sub>    |                  | - 0.3 to V <sub>DD</sub> + 0.3 | V    |    |
| Output Voltage                              | V <sub>OUT</sub>   |                  | - 0.3 to V <sub>DD</sub> + 0.3 | V    |    |
| Output Current (Per 1 pin)                  | I <sub>OUT1</sub>  | Port R5, R6      | 30                             | mA   |    |
|   | I <sub>OUT2</sub>  | Port R4          | 15                             |      |    |
|   | I <sub>OUT3</sub>  | Ports R7, R8, R9 | 3.2                            |      |    |
| Output Current (Total)                      | Σ I <sub>OUT</sub> | Port R4, R5, R6  | 120                            | mA   |    |
| Power Dissipation [T <sub>opr</sub> = 70°C] | PD                 |                  | DIP                            | 300  | mW |
|   |                    |                  | SOP                            | 180  |    |
| Soldering Temperature (time)                | T <sub>sld</sub>   |                  | 260 (10 s)                     | °C   |    |
| Storage Temperature                         | T <sub>stg</sub>   |                  | - 55 to 125                    | °C   |    |
| Operating Temperature                       | T <sub>opr</sub>   |                  | - 30 to 70                     | °C   |    |

*Note: The absolute maximum ratings are rated values which must not be exceeded during operation, even for an instant. Any one of the ratings must not be exceeded. If any absolute maximum rating is exceeded, a device may break down or its performance may be degraded, causing it to catch fire or explode resulting in injury to the user. Thus, when designing products which include this device, ensure that no absolute maximum rating value will ever be exceeded.*

Recommended Operating Conditions (V<sub>SS</sub> = 0 V, T<sub>opr</sub> = - 30 to 70°C)

| Parameter          | Symbol           | Pins                    | Conditions                     | Min                    | Max                    | Unit |
|--------------------|------------------|-------------------------|--------------------------------|------------------------|------------------------|------|
| Supply Voltage     | V <sub>DD</sub>  |                         | fc = 6.0 MHz                   | 4.5                    | 5.5                    | V    |
|                    |                  |                         | fc = 4.2 MHz                   | 2.7                    |                        |      |
|                    |                  |                         | HOLD mode                      | 2.0                    |                        |      |
| Input High Voltage | V <sub>IH1</sub> | Except Hysteresis Input | In the normal operating area   | V <sub>DD</sub> × 0.7  | V <sub>DD</sub>        | V    |
|                    | V <sub>IH2</sub> | Hysteresis Input        |                                | V <sub>DD</sub> × 0.75 |                        |      |
|                    | V <sub>IH3</sub> |                         | In the HOLD mode               | V <sub>DD</sub> × 0.9  |                        |      |
| Input Low Voltage  | V <sub>IL1</sub> | Except Hysteresis Input | In the normal operating area   | 0                      | V <sub>DD</sub> × 0.3  | V    |
|                    | V <sub>IL2</sub> | Hysteresis Input        |                                |                        | V <sub>DD</sub> × 0.25 |      |
|                    | V <sub>IL3</sub> |                         | In the HOLD mode               |                        | V <sub>DD</sub> × 0.1  |      |
| Clock Frequency    | fc               | XIN, XOUT               | V <sub>DD</sub> = 4.5 to 5.5 V | 0.4                    | 6.0                    | MHz  |
|                    |                  |                         | V <sub>DD</sub> = 2.7 to 5.5 V |                        | 4.2                    |      |

*Note: The recommended operating conditions for a device are operating conditions under which it can be guaranteed that the device will operate as specified. If the device is used under operating conditions other than the recommended operating conditions (supply voltage, operating temperature range, specified AC/DC values etc.), malfunction may occur. Thus, when designing products which include this device, ensure that the recommended operating conditions for the device are always adhered to.*

## DC Characteristics

(V<sub>SS</sub> = 0 V, T<sub>opr</sub> = -30 to 70°C)

| Parameter   | Symbol           | Pins                    | Conditions   | Min | Typ. | Max | Unit |
|---|------------------|-------------------------|--|-----|------|-----|------|
| Hysteresis Voltage                                  | V <sub>HS</sub>  | Hysteresis Input        |  | -   | 0.7  | -   | V    |
| Input Current                                       | I <sub>IN1</sub> | RESET, HOLD             | V <sub>DD</sub> = 5.5 V, V <sub>IN</sub> = 5.5 V / 0 V | -   | -    | ±2  | μA   |
|   | I <sub>IN2</sub> | Open drain output ports |  |     |      |     |      |
| Input Resistance                                    | R <sub>IN</sub>  | RESET                   |  | 100 | 220  | 450 | kΩ   |
| Input Low Current                                   | I <sub>IL</sub>  | Push-pull output ports  | V <sub>DD</sub> = 5.5 V, V <sub>IN</sub> = 0.4 V       | -   | -    | -2  | mA   |
| Output Leakage Current                              | I <sub>LO</sub>  | Open drain output ports | V <sub>DD</sub> = 5.5 V, V <sub>OUT</sub> = 5.5 V      | -   | -    | 2   | μA   |
| Output Low Voltage                                  | V <sub>OL</sub>  | Port R7, R8, R9         | V <sub>DD</sub> = 4.5 V, I <sub>OL</sub> = 1.6 mA      | -   | -    | 0.4 | V    |
| Output Low Current                                  | I <sub>OL1</sub> | Port R5, R6             | V <sub>DD</sub> = 4.5 V, V <sub>OL</sub> = 1.0 V       | -   | 20   | -   | mA   |
|   | I <sub>OL2</sub> | Port R4                 |  | -   | 7    | -   |      |
| Supply Current<br>(in the Normal<br>operating mode) | I <sub>DD</sub>  |                         | V <sub>DD</sub> = 5.5 V, f <sub>c</sub> = 4 MHz        | -   | 2    | 4   | mA   |
|   |                  |                         | V <sub>DD</sub> = 3.0 V, f <sub>c</sub> = 4 MHz        | -   | 1    | 2   |      |
|   |                  |                         | V <sub>DD</sub> = 3.0 V, f <sub>c</sub> = 400 kHz      | -   | 0.5  | 1   |      |
| Supply Current<br>(in the HOLD<br>operating mode)   | I <sub>DDH</sub> |                         | V <sub>DD</sub> = 5.5 V                                | -   | 0.5  | 10  | μA   |

Note 1: Typ. values show those at T<sub>opr</sub> = 25°C, V<sub>DD</sub> = 5 V.

Note 2: Input Current I<sub>IN1</sub>: The current through resistor is not included.

Note 3: Supply Current: V<sub>IN</sub> = 5.3 V / 0.2 V (V<sub>DD</sub> = 5.5 V), 2.8 V / 0.2 V (V<sub>DD</sub> = 3.0 V)



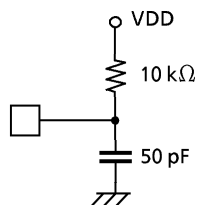
AC Characteristics

( $V_{SS} = 0\text{ V}$ ,  $T_{opr} = -30\text{ to }70^\circ\text{C}$ )

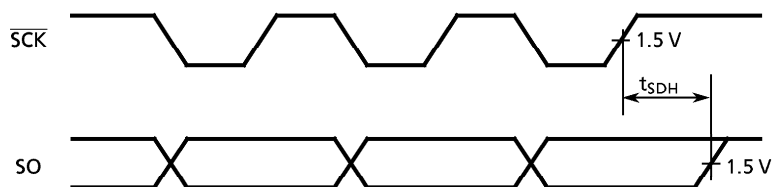
| Parameter                    | Symbol    | Conditions                            | Min                | Typ. | Max | Unit          |
|------------------------------|-----------|---------------------------------------|--------------------|------|-----|---------------|
| Instruction Cycle Time       | $t_{cy}$  | $V_{DD} = 4.5\text{ to }5.5\text{ V}$ | 1.3                | -    | 20  | $\mu\text{s}$ |
|                              |           | $V_{DD} = 2.7\text{ to }5.5\text{ V}$ | 1.9                |      |     |               |
| High level Clock pulse Width | $t_{WCH}$ | For external clock operation          | 80                 | -    | -   | ns            |
| Low level Clock pulse Width  | $t_{WCL}$ |                                       |                    |      |     |               |
| Shift data Hold Time         | $t_{SDH}$ |                                       | $0.5 t_{cy} - 0.3$ | -    | -   | $\mu\text{s}$ |

Note: Shift data Hold Time:

External circuit for pins  $\overline{\text{SCK}}$  and SO



Serial port (completed of transmission)



Recommended Oscillating Conditions

( $V_{SS} = 0\text{ V}$ ,  $V_{DD} = 4.5\text{ to }5.5\text{ V}$ ,  $T_{opr} = -30\text{ to }70^\circ\text{C}$ )

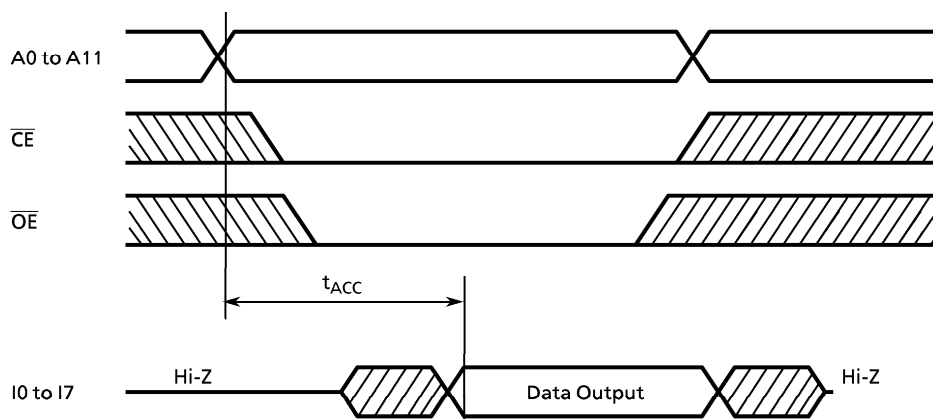
Recommended oscillating conditions of the TMP47P403V are equal to the TMP47C103/203's but RC oscillation is impossible.

DC/AC Characteristics

( $V_{SS} = 0\text{ V}$ )

(1) Read Operation

| Parameter                 | Symbol    | Condition                        | Min                 | Typ. | Max                 | Unit |
|---------------------------|-----------|----------------------------------|---------------------|------|---------------------|------|
| Output Level High Voltage | $V_{IH4}$ |                                  | $V_{CC} \times 0.7$ | -    | $V_{CC}$            | V    |
| Output Level Low Voltage  | $V_{IL4}$ |                                  | 0                   | -    | $V_{CC} \times 0.3$ | V    |
| Supply Voltage            | $V_{CC}$  |                                  | 4.75                | -    | 6.0                 | V    |
| Programming Voltage       | $V_{PP}$  |                                  |                     |      |                     |      |
| Address Access Time       | $t_{ACC}$ | $V_{CC} = 5.0 \pm 0.25\text{ V}$ | 0                   | -    | 350                 | ns   |



(2) High Speed Programming Operation

| Parameter                     | Symbol    | Condition                 | Min                 | Typ.  | Max                 | Unit |
|-------------------------------|-----------|---------------------------|---------------------|-------|---------------------|------|
| Input High Voltage            | $V_{IH4}$ |                           | $V_{CC} \times 0.7$ | –     | $V_{CC}$            | V    |
| Input Low Voltage             | $V_{IL4}$ |                           | 0                   | –     | $V_{CC} \times 0.3$ | V    |
| Supply Voltage                | $V_{CC}$  |                           | 4.75                | –     | 6.0                 | V    |
| $V_{PP}$ Power Supply Voltage | $V_{PP}$  |                           | 12.00               | 12.50 | 13.00               | V    |
| Programming Pulse Width       | $t_{PW}$  | $V_{CC} = 6.0 \pm 0.25$ V | 0.95                | 1.0   | 1.05                | ms   |

